

06-12-1998

HEET

Attorney Dkt. 2271/55515

To the Honorable Commissioner

100736830

Attached original documents or copy thereof.

1. Name of conveying parties:

Name and address of receiving party(ies):

Masaya OHTSUKA, 2) Takeshi NANJYO, and  
3) Ikuo KAWASHIMA

Name: Ricoh Company, Ltd.

Internal Address: \_\_\_\_\_

Additional name(s) of conveying party(ies) attached?

☐ Yes ☒ No

Street Address: 3-6, Nakamagome 1-Chome, Ohta-Ku

City/Country Tokyo 143-8555, JAPAN

Additional name(s) & address(es) attached?

☐ Yes ☒ No

Nature of Conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other \_\_\_\_\_

Execution Date: 1) May 6, 1998, 2) April 24, 1998, and  
3) April 28, 1998

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s) S.N. 09/005,724  
filed January 13, 1998

B. Patent No.(s)

Additional numbers attached?

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

6. Total number of applications and patents involved: 1

Name: Richard F. Jaworski, Esq.

7. Total fee (37 CFR 3.41): ..... \$ 40

☒ Enclosed

Internal Address: \_\_\_\_\_

☐ Authorized to be charged to Deposit Account

Street Address: Cooper & Dunham LLP

8. Deposit account number:

1185 Avenue of the Americas

03-3125

City: New York State: N.Y. ZIP 10036

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

05/26/1998 Richard F. Jaworski, Esq. No. 33515  
Name of Person Signing

Signature

Date

May 12, 1998

02 FC:581

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## **ASSIGNMENT**

*In consideration of One Dollar (\$1.00), and other good and valuable considerations, the receipt of which is hereby acknowledged, we, the undersigned,*

*Masaya OHTSUKA, now residing at 1154-1 Mizoguchi, Kohdera-cho,  
Kanzaki-gun, Hyogo-ken, Japan;*

*Takeshi NANJYO, now residing at 109-6 Yasuda, Onoye-cho, Kakogawa-  
shi, Hyogo-ken, Japan; and*

*Ikue KAWASHIMA, now residing at 1-12-6 Hino, Kohnan-ku, Yokohama-shi,  
Kanagawa-ken, Japan*

*Hereby sell, assign and transfer to RICOH COMPANY, LTD., a corporation of Japan, having a place of business at 3-6, Nakamagome 1-chome, Ohta-ku, Tokyo 143-8555, Japan, its successors, assigns and legal representatives, the entire right, title and interest for all countries, in and to any and all inventions which are disclosed and claimed, and as possessed by the undersigned, any and all inventions which are disclosed but not claimed, in the application for United States Patent, which was executed by the undersigned concurrently herewith and is entitled*

### **SEMICONDUCTOR DEVICE AND METHOD OF FORMING SEMICONDUCTOR DEVICE HAVING NON-UNIFORMLY DOPED WELL**

**(Application S.N. 09/005,724 filed January 13, 1998)**

*and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for U.S. Letters Patent or other related property rights in any and all foreign countries which have been or shall be filed on any of said inventions disclosed in said application; and in and to all original and reissued patents or related foreign documents which have been or shall be issued on said inventions;*

*Authorize and request the Commissioner of Patents of the United States to issue to said Assignee, the corporation above named, its successors, assigns and legal representatives, in accordance with this assignment, any and all United States Letters Patent on said*

inventions or any of them disclosed in said application;

Agree that said Assignee may apply for and receive foreign Letters Patent or rights of any other kind for said inventions, or any of them; and may claim, in applications for said foreign Letters Patent or other rights, the priority of the aforesaid United States patent application under the provisions of the International Convention of 1883 and later modifications thereof, under the Patent Cooperation Treaty, under the European Patent Convention or under any other available international agreement; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned or the undersigned's executors or administrators will, for the United States and all foreign countries, execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications or other documents on any and all said inventions; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns and representatives, all facts known and documents available to the undersigned relating to said inventions and the history thereof; testify in all legal proceedings; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said inventions and for vesting title to said inventions and all applications for patents or related foreign rights and all patents on said inventions, in said Assignee, its successors, assigns and legal representatives; and

**COVENANT** with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Masaya Ohtsuka [L.S.]  
Masaya OHTSUKA

Date: May 6, 1998

Witness: \_\_\_\_\_

\_\_\_\_\_  
\_\_\_\_\_

Takeshi Nanjyo [L.S.]  
Takeshi NANJYO

Date: 27. 4. 1998

Witness: \_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_

Ikuo Kawashima [L.S.]  
Ikuo KAWASHIMA

Date: April. 28, 1998

Witness: \_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_